

Metallized Polypropylene (PP) RFI-Capacitors Class Y2 PCM 10 mm and 15 mm

Special Features

- Reliable self-healing
- High degree of interference suppression due to good attenuation and low ESR
- According to RoHS 2002/95/EC

Typical Applications

Class Y2 RFI applications to meet EMC regulations

- Capacitors connected to the mains between phase or neutral and earthed casing
- By-passing of the basic or supplementary insulation, pulse peak voltage ≤ 5 kV
- According to cULus also approved for X1 applications

Construction

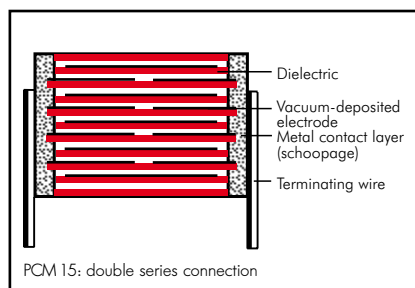
Dielectric:

Polypropylene (PP) film

Capacitor electrodes:

Vacuum-deposited

Internal construction:



Encapsulation:

Solvent-resistant, flame-retardant plastic case with epoxy resin seal, UL 94 V-0

Terminations:

Tinned wire.

Marking:

Colour: Red. Marking: Black.

Electrical Data

Capacitance range:

1000 pF to 0.022 μ F

Rated voltage:

300 VAC

Continuous DC voltage* (general guide): ≤ 1000 V

Capacitance tolerances:

$\pm 20\%$, $\pm 10\%$

Operating temperature range:

-55°C to $+105^{\circ}\text{C}$

Climatic test category:

55/105/56/C in accordance with IEC

Insulation resistance at $+20^{\circ}\text{C}$:

$\geq 15 \times 10^3$ M Ω

Measuring voltage: 100 V/1 min.

Test specifications:

In accordance with DIN EN 60384-14

Approvals:

Country	Authority	Specification	Symbol	Approval-No.
Germany	VDE	DIN EN 132 400 IEC 60384-14/2		40008997
USA/Canada	UL	UL 1414 (250 VAC) C 22.2 No. 1 (250 VAC)		E 134915

Dissipation factors at $+20^{\circ}\text{C}$: $\tan \delta$

at f	$C \leq 0.022 \mu\text{F}$
1 kHz	$\leq 10 \times 10^{-4}$
100 kHz	$\leq 50 \times 10^{-4}$

Maximum pulse rise time:

100 V/ μ sec for pulses equal to a voltage amplitude with $\sqrt{2} \times 300$ VAC = 425 V according to IEC 60384-14

Test voltage:

2700 VDC, 2 sec.

Reliability:

Operational life > 300 000 hours

Failure rate < 2 fit (0.5 $\times$ U_r and 40°C)

Mechanical Tests

Pull test on leads:

10 N in direction of leads according to IEC 60068-2-21

Vibration:

6 hours at 10 ... 2000 Hz and 0.75 mm displacement amplitude or 10 g in accordance with IEC 60068-2-6

Low air density:

1 kPa = 10 mbar in accordance with IEC 60068-2-13

Bump test:

4000 bumps at 390 m/sec² in accordance with IEC 60068-2-29

Packing

Available taped and reeled.

Detailed taping information and graphs at the end of the catalogue.

For further details and graphs please refer to Technical Information.

* If safety-approved EMI suppression capacitors are operated with a DC voltage being above the specified AC voltage rating the given approvals are no longer valid (DIN EN 60384-14).

Furthermore the permissible pulse rise time du/dt ($F_{\text{max.}}$) will be subject to a reduction according to

$$F_{\text{max.}} = F_r \times \sqrt{2} \times U_{\text{AC}} / U_{\text{DC}}$$

if the DC operating voltage U_{DC} is higher than $\sqrt{2} \times U_{\text{AC}}$

Continuation

General Data

Capacitance	W	H	L	PCM**
300 VAC*				
1000 pF	4	9.5	13	10
1500 "	4	9.5	13	10
2200 "	4	9.5	13	10
3300 "	5	11	13	10
4700 "	5	11	13	10
6800 "	6	12.5	13	10
0.01 µF	5	11	18	15
0.015 "	6	12.5	18	15
0.022 "	7	14	18	15

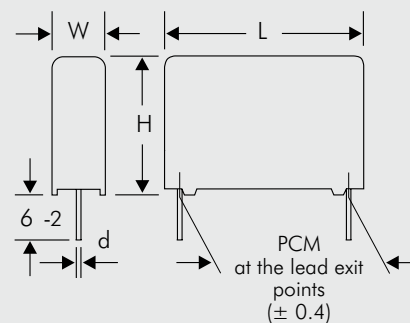
* f = 50/60 Hz

** PCM = Printed circuit module = lead spacing

Dims. in mm.

Taped version see page 121.

d = 0.6 ø if PCM 10
d = 0.8 ø if PCM 15



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Recommendation for Processing and Application of Through-Hole Capacitors

Soldering Process

A preheating of through-hole WIMA capacitors is allowed for temperatures $T_{\max} < 100^{\circ}\text{C}$. In practice a preheating duration of $t < 5$ min. has been proven to be best.

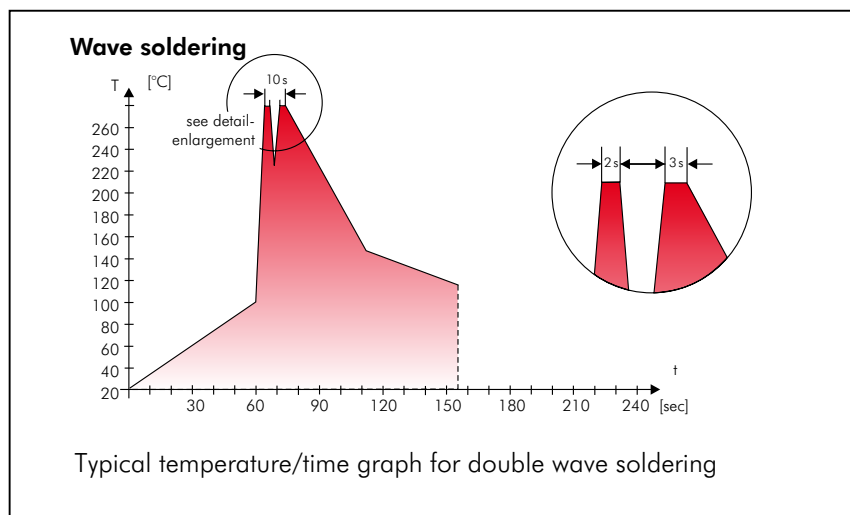
Single wave soldering

Soldering bath temperature: $T < 260^{\circ}\text{C}$
Immersion time: $t < 5$ sec

Double wave soldering

Soldering bath temperature: $T < 260^{\circ}\text{C}$
Immersion time: $2 \times t < 3$ sec

Due to different soldering processes and heat requirements the graphs are to be regarded as a recommendation only.



WIMA Quality and Environmental Philosophy

ISO 9001:2000 Certification

ISO 9001:2000 is an international basic standard of quality assurance systems for all branches of industry. The approval according to ISO 9001:2000 of our factories by the VDE inspectorate certifies that organisation, equipment and monitoring of quality assurance in our factories correspond to internationally recognized standards.

WIMA WPCS

The WIMA Process Control System (WPCS) is a quality surveillance and optimization system developed by WIMA. WPCS is a major part of the quality-oriented WIMA production. Points of application of WPCS during production process:

- incoming material inspection
- metallization
- film inspection
- schoopage
- pre-healing
- lead attachment
- cast resin preparation/encapsulation
- 100% final inspection
- AQL check

WIMA Environmental Policy

All WIMA capacitors, irrespective of whether through-hole devices or SMD, are made of environmentally friendly materials. Neither during manufacture nor in the product itself any toxic substances are used, e.g.

- | | |
|------------------------|------------|
| – Lead | – PBB/PBDE |
| – PCB | – Arsenic |
| – CFC | – Cadmium |
| – Hydrocarbon chloride | – Mercury |
| – Chromium 6+ | – etc. |

We merely use pure, recyclable materials for packing our components, such as:

- carton
- cardboard
- adhesive tape made of paper
- polystyrene

We almost completely refrain from using packing materials such as:

- foamed polystyrene (Styropor®)
- adhesive tapes made of plastic
- metal clips

RoHS Compliance

According to the RoHS Directive 2002/95/EC certain hazardous substances like e.g. lead, cadmium, mercury must not be used any longer in electronic equipment as of July 1st, 2006. For the sake of the environment WIMA has refrained from using such substances since years already.



WIMA Kondensatoren sind bleifrei
konform RoHS 2002/95/EG

WIMA capacitors are lead free
in accordance with RoHS 2002/95/EC

Tape for lead-free WIMA capacitors

DIN EN ISO 14001:2005

WIMA's environmental management has been established in accordance with the guidelines of DIN EN ISO 14001:2005. The certification has been granted in June 2006.

Typical Dimensions for Taping Configuration

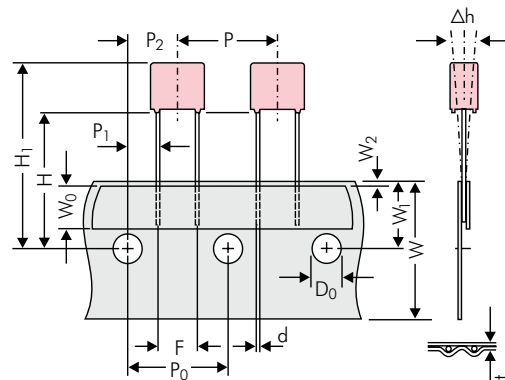


Diagram 1:
PCM 2.5/5/7.5mm

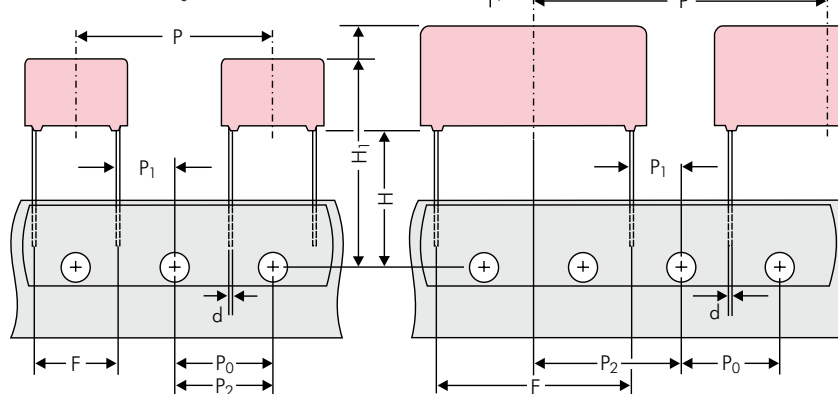


Diagram 2: PCM 10/15 mm

Diagram 3: PCM 22.5 and 27.5*mm

*PCM 27.5 taping possible with two feed holes between components

Designation	Symbol	Dimensions for Radial Taping						
		PCM 2.5 taping	PCM 5 taping	PCM 7.5 taping	PCM 10 taping*	PCM 15 taping*	PCM 22.5 taping	PCM 27.5 taping
Carrier tape width	W	18.0 ±0.5	18.0 ±0.5	18.0 ±0.5	18.0 ±0.5	18.0 ±0.5	18.0 ±0.5	18.0 ±0.5
Hold-down tape width	W ₀	6.0 for hot-sealing adhesive tape	6.0 for hot-sealing adhesive tape	12.0 for hot-sealing adhesive tape	12.0 for hot-sealing adhesive tape	12.0 for hot-sealing adhesive tape	12.0 for hot-sealing adhesive tape	12.0 for hot-sealing adhesive tape
Hole position	W ₁	9.0 ±0.5	9.0 ±0.5	9.0 ±0.5	9.0 ±0.5	9.0 ±0.5	9.0 ±0.5	9.0 ±0.5
Hold-down tape position	W ₂	0.5 to 3.0 max.	0.5 to 3.0 max.	0.5 to 3.0 max.	0.5 to 3.0 max.	0.5 to 3.0 max.	0.5 to 3.0 max.	0.5 to 3.0 max.
Feed hole diameter	D ₀	4.0 ±0.2	4.0 ±0.2	4.0 ±0.2	4.0 ±0.2	4.0 ±0.2	4.0 ±0.2	4.0 ±0.2
Pitch of component	P	12.7 ±1.0	12.7 ±1.0	12.7 ±1.0	25.4 ±1.0	25.4 ±1.0	38.1 ±1.5	38.1 ±1.5 or 50.8 ±1.5
Feed hole pitch	P ₀	12.7 ±0.3 cumulative pitch error max. 1.0 mm/20 pitch	12.7 ±0.3 cumulative pitch error max. 1.0 mm/20 pitch	12.7 ±0.3 cumulative pitch error max. 1.0 mm/20 pitch	12.7 ±0.3 cumulative pitch error max. 1.0 mm/20 pitch	12.7 ±0.3 cumulative pitch error max. 1.0 mm/20 pitch	12.7 ±0.3 cumulative pitch error max. 1.0 mm/20 pitch	12.7 ±0.3 cumulative pitch error max. 1.0 mm/20 pitch
Feed hole centre to lead	P ₁	5.1 ±0.5	3.85 ±0.7	2.6 ±0.7	7.7 ±0.7	5.2 ±0.7	7.8 ±0.7	5.3 ±0.7
Hole centre to component centre	P ₂	6.35 ±1.3	6.35 ±1.3	6.35 ±1.3	12.7 ±1.3	12.7 ±1.3	19.05 ±1.3	19.05 ±1.3
Feed hole centre to bottom edge of the component	H _▲	16.5 ±0.3 18.5 ±0.5	16.5 ±0.3 18.5 ±0.5	16.5 ±0.5 18.5 ±0.5	16.5 ±0.5 18.5 ±0.5	16.5 ±0.5 18.5 ±0.5	16.5 ±0.5 18.5 ±0.5	16.5 ±0.5 18.5 ±0.5
Feed hole centre to top edge of the component	H ₁	H+H _{component} < H ₁ 32.25 max.	H+H _{component} < H ₁ 32.25 max.	H+H _{component} < H ₁ 24.5 to 31.5	H+H _{component} < H ₁ 25.0 to 31.5	H+H _{component} < H ₁ 26.0 to 37.0	H+H _{component} < H ₁ 30.0 to 43.0	H+H _{component} < H ₁ 35.0 to 45.0
Lead spacing at upper edge of carrier tape	F	2.5 ±0.5	5.0 ^{+0.8} _{-0.2}	7.5 ±0.8	10.0 ±0.8	15 ±0.8	22.5 ±0.8	27.5 ±0.8
Lead diameter	d	0.4 ±0.05	0.5 ±0.05	0.5 ±0.05 or 0.6 ^{+0.06} _{-0.05}	0.5 ±0.05 or 0.6 ^{+0.06} _{-0.05}	0.8 ^{+0.08} _{-0.05}	0.8 ^{+0.08} _{-0.05}	0.8 ^{+0.08} _{-0.05}
Component alignment	Δh	± 2.0 max.	± 2.0 max.	± 3.0 max.	± 3.0 max.	± 3.0 max.	± 3.0 max.	± 3.0 max.
Total tape thickness	t	0.7 ±0.2	0.7 ±0.2	0.7 ±0.2	0.7 ±0.2	0.7 ±0.2	0.7 ±0.2	0.7 ±0.2
Package (see also page 122)	▲	ROLL/AMMO			AMMO			
		REEL ø 360 max. ø 30 ±1	B 52 ±2 58 ±2 } depending on comp. dimensions		REEL ø 360 max. ø 30 ±1	52 ±2 58 ±2 or 66 ±2	REEL ø 500 max. ø 25 ±1	54 ±2 60 ±2 68 ±2 } depending on PCM and component dimensions
Unit		see details page 124.						

▲ Please give „H“ dimensions and desired packaging type when ordering.

Dims in mm.

• Diameter of leads see General Data.

Please clarify customer-specific deviations with the manufacturer.

* PCM 10 and PCM 15 can be crimped to PCM 7.5.

Position of components according to PCM 7.5 (sketch 11). P₀ = 12.7 or 15.0 is possible